

1 Scope

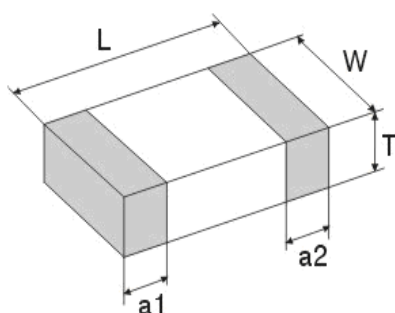
This specification applies to the HDHB series of multilayer chip high frequency bead.

2 Product Identification

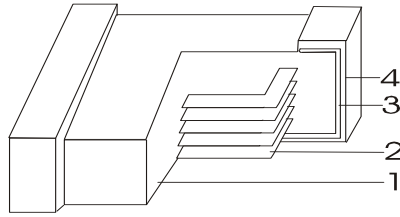
<u>HDHB</u>	<u>1608</u>	<u>K</u>	<u>102</u>	<u>T</u>	<u>-LF</u>
①	②	③	④	⑤	⑥

- ① Product Symbol (HDHB)
- ② Dimensions
- ③ Material Code
- ④ Impedance Value 102: 1000Ω,
- ⑤ Packaging Style (B: Bulk; T: Tape & Reel)
- ⑥ Lead Free

3 Appearance, Dimensions and Material



Type	Dimensions (mm) [inch]			
	L	W	T	a1, a2
0603 [0201]	0.60±0.05 [0.024±0.002]	0.30±0.05 [0.012±0.002]	0.30±0.05 [0.012±0.002]	0.15±0.05 [0.006±0.002]
1005 [0402]	1.00±0.15 [0.04±0.006]	0.50±0.15 [0.02±0.006]	0.50±0.15 [0.02±0.006]	0.25±0.10 [0.01±0.004]
1608 [0603]	1.60±0.15 [0.063±0.006]	0.80±0.15 [0.031±0.006]	0.80±0.15 [0.031±0.006]	0.30±0.20 [0.012±0.008]
2012 [0805]	2.00±0.20 [0.079±0.008]	1.25±0.20 [0.049±0.008]	0.85±0.20 [0.033±0.008]	0.50±0.30 [0.02±0.012]



	Composition	Material	Supplier
1	Base Material	Ferrite	Japan
2	Internal Conductor	Ag	Japan
3	Terminal Electrode	Ag	Japan
4	Terminal Electrode	Ni-Sn	USA

4 Testing Conditions

<Unless otherwise specified>

Temperature : Ordinary Temperature (5 to 35°C)

Humidity : Ordinary Humidity (25 to 85% RH)

<In case of doubt>

Temperature : 20±2°C

Humidity : 60 to 75% RH

Atmospheric Pressure : 86 to 106 kPa

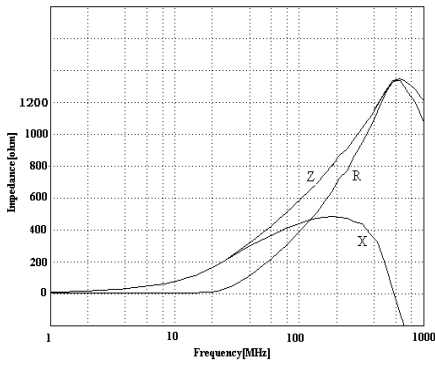
5 Rating

Operating Temperature Range : -55 to +125°C

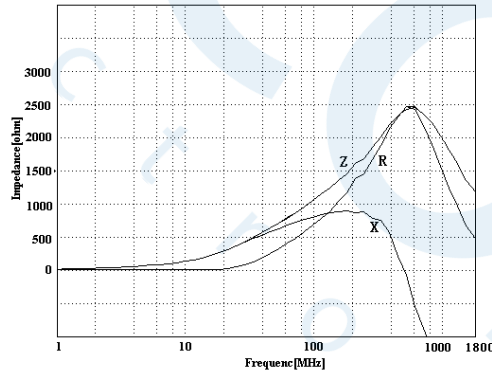
Storage Temperature Range : -55 to +125°C

Customer Part No.	HONGDA Part No.	Impedance (Ω)		RDC (Ω) max	Rated Current (mA)max
		@ 100MHz	@ 1000MHz		
	HDHB1005S601T-LF	600 \pm 25%	1400 \pm 40%	1.50	300
	HDHB1005S102T-LF	1000 \pm 25%	2000 \pm 40%	1.50	250
	HDHB1005S182T-LF	1800 \pm 25%	2700 \pm 40%	2.20	200
	HDHB1608S601T-LF	600 \pm 25%	700.Typ	1.00	200
	HDHB1608S102T-LF	1000 \pm 25%	700.Typ	1.60	150
	HDHB1608K601T-LF	600 \pm 25%	1200.Typ	1.50	100
	HDHB1608K102T-LF	1000 \pm 25%	1700.Typ	1.80	50

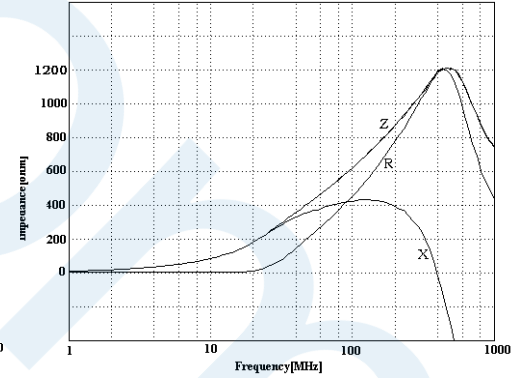
HDHB1005S601T



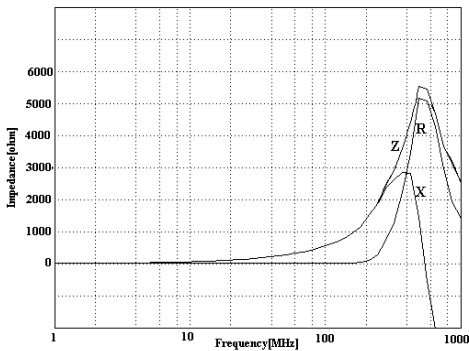
HDHB1005S102T



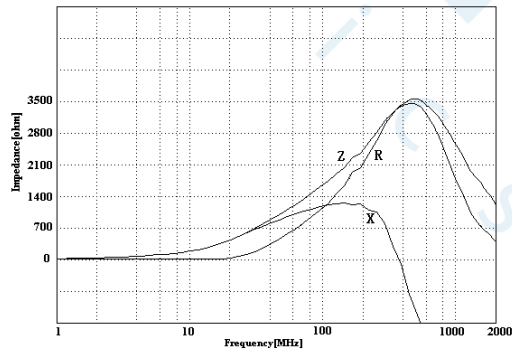
HDHB1608S601T



HDHB1608K601T



HDHB1005S182T





6 Electrical Performance

6.1 Impedance

Impedance shall meet item 5 when measured on the condition of Table 1.

Table 1

Measuring Equipment	Impedance analyzer HP4291 or equivalent
Measuring Frequency	(see item 5)
Measuring signal level	50mV

6.2 DC Resistance

D.C Resistance shall meet item 5 when measured on the condition of Table 2.

Table 2

Measuring Equipment	LCR Meter HP4263A or equivalent
---------------------	---------------------------------

6.3 Rated current

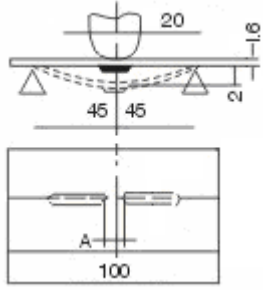
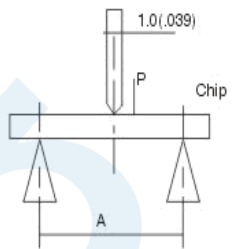
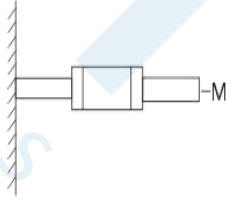
Chip surface temperature rise just 20°C against chip surface temperature when the allowable current (which is mentioned in item 5) is applied.

Table 3

Measuring Equipment	Electric Power Supplier, Electric Current Meter, Thermometer
---------------------	--



7 Reliable Performance

NO.	Item	Specifications	Test Methods															
1	Solder-Ability	More than 90% of termination should be covered with new solder.	Solder : Sn Temperature : 255°C+5°C/-0°C Flux : rosin Duration : 3.5±0.5s															
2	Leaching Resistance	More than 75% of termination Should be covered with new solder.	Solder : Sn Temperature : 270°C+2°C/-0°C Flux : rosin Duration : 10±0.5s															
3	Bending Strength	No mechanical damage should be noticed	When the board curve to 2mm(0.079 inches) <table border="1"> <thead> <tr> <th>Size</th> <th>A(mm)</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td>0.3</td> </tr> <tr> <td>1005</td> <td>0.5</td> </tr> <tr> <td>1608</td> <td>0.7</td> </tr> <tr> <td>2012</td> <td>1.0</td> </tr> </tbody> </table> 	Size	A(mm)	0603	0.3	1005	0.5	1608	0.7	2012	1.0					
Size	A(mm)																	
0603	0.3																	
1005	0.5																	
1608	0.7																	
2012	1.0																	
4	Body Strength	No mechanical damage should be noticed	Applied specified pull strength in axial direction <table border="1"> <thead> <tr> <th>Size</th> <th>A/mm</th> <th>P/N</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td>0.3</td> <td>4.9</td> </tr> <tr> <td>1005</td> <td>0.7</td> <td>4.9</td> </tr> <tr> <td>1608</td> <td>1.0</td> <td>4.9</td> </tr> <tr> <td>2012</td> <td>1.4</td> <td>9.8</td> </tr> </tbody> </table> 	Size	A/mm	P/N	0603	0.3	4.9	1005	0.7	4.9	1608	1.0	4.9	2012	1.4	9.8
Size	A/mm	P/N																
0603	0.3	4.9																
1005	0.7	4.9																
1608	1.0	4.9																
2012	1.4	9.8																
5	Terminal Strength	The terminal and body should be no damage	Applied specified pull strength in axial <table border="1"> <thead> <tr> <th>Size</th> <th>Pull Strength</th> <th>Time (s)</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td>2 N</td> <td>5±1</td> </tr> <tr> <td>1005</td> <td>3 N</td> <td>5±1</td> </tr> <tr> <td>1608</td> <td>5 N</td> <td>5±1</td> </tr> <tr> <td>2012</td> <td>10 N</td> <td>5±1</td> </tr> </tbody> </table> 	Size	Pull Strength	Time (s)	0603	2 N	5±1	1005	3 N	5±1	1608	5 N	5±1	2012	10 N	5±1
Size	Pull Strength	Time (s)																
0603	2 N	5±1																
1005	3 N	5±1																
1608	5 N	5±1																
2012	10 N	5±1																



NO.	Item	Specifications	Test Methods
6	Drop		Drop 10 times on a concrete floor from a height of 1m.
7	Vibration		Frequency : 10 to 55Hz Amplitude : 1.52mm Direction and time : X, Y and Z directions for 2 hours each.
8	Humidity resistance		a. Test condition Temp. : 60±2°C Humidity : 90%~95% Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
9	High temperature resistance	1.No mechanical damage shall be noticed 2.Impedance shall be within ±20% of the initial value	a. Test condition Applied rated current Temp. : 125±2°C Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
10	Low temperature resistance		a. Test condition Temp. : -55±2°C Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
11	Thermal shock		a. Test condition 1) Temp. : -55°C, time: 30±3min 2) Temp. : +125°C, time: 30±3min 100 cycles b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.

8 Recommended Soldering Conditions

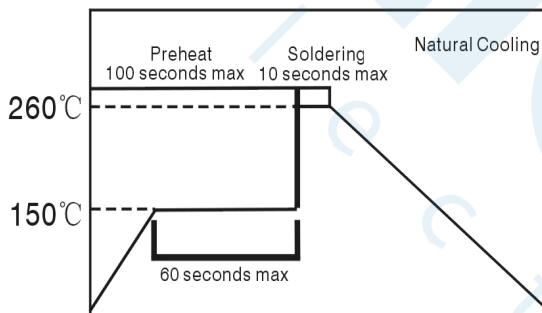
Product can be applied to flow and reflow soldering.

(1) Flux, Solder

- ① Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).
- ② Use Sn solder.

(2) Flow soldering conditions

- ① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.
- ② Standard soldering profile.



Pre-heating	150°C, 1 minute min
Peak	260°C, 10 seconds max

(3) Reflow soldering conditions

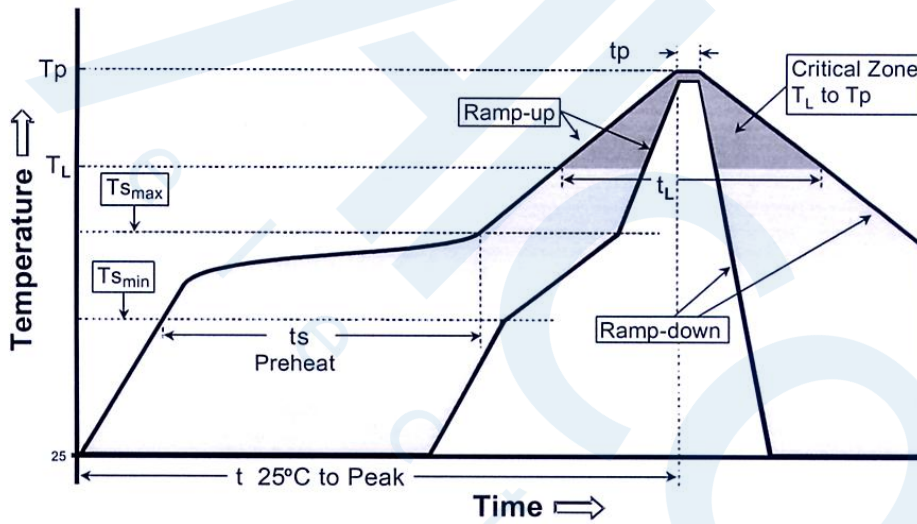
Profile Feature	Lead-Free Assembly
Average Ramp-Up Rate (T _{smax} to T _p)	3°C /second max.
Preheat Temperature Min (T _{smin}) Temperature Max (T _{smax}) Time (t _{smin} to t _{smax}) min to t _{smax})	150 °C 200 °C 60-180 seconds



Profile Feature	Lead-Free Assembly
Time maintained above: Temperature (TL) Time (tL)	217 °C 60-150 seconds
Peak/Classification Temperature (Tp) Peak/Classification Time (Tp)	260 °C 3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Standard soldering profile



(4) Reworking with soldering iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C, 1 minute
Tip temperature	350°C max
Soldering iron output	80w max
End of soldering iron	φ 1mm max
Soldering time	3 seconds max



9 Cleaning Conditions

- (1) Products shall be cleaned on the following conditions.

Cleaning temperature shall be limited to 60°C max.(40°C max for fluoride and alcohol type cleaner.)

- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power : 20W/t max

Frequency: 40 kHz

Time : 5 minutes max

- (3) Cleaner

- a) Alternative cleaner

Isopropyl alcohol (IPA) HCFC -225

- b) Aqueous agent

Surface Active Agent Type (CLEANTHROUGH 750H)

Hydrocarbon Type (TECHNOCLEANER 335)

Higher Alcohol Type (PINE ALPHA ST -100S)

Alkali Saponification Type (*AQUACLEANER 240)

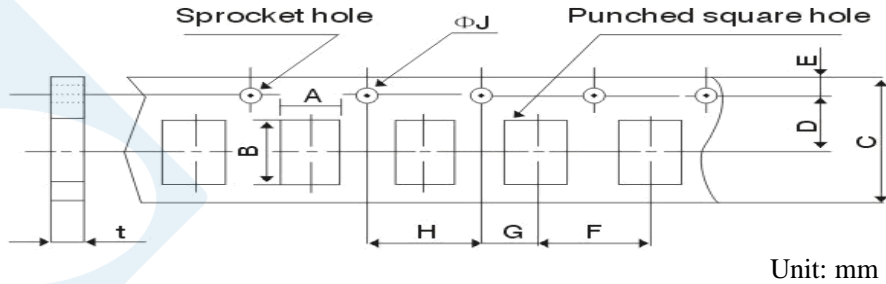
- (4) There shall be no residual flux and residual cleaner after cleaning. In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning Please contact us.



10 Packaging

(1) Dimensions of Tape:

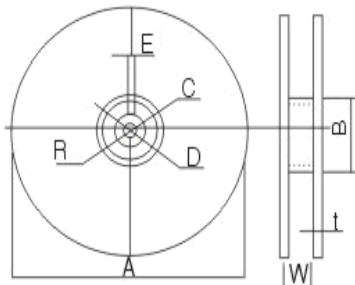
Paper / Embossed carrier tape:



Type	2012	1608	1005	0603
T*	0.85±0.2	0.8±0.15	0.5±0.15	0.3±0.05
	Paper carrier tape	Paper carrier tape	Paper carrier tape	Paper carrier tape
A	1.5±0.15	1.05±0.15	0.65±0.10	0.4±0.05
B	2.5±0.2	1.9±0.15	1.15±0.10	0.7±0.05
C	8.0±0.3	8.0±0.3	8.0±0.3	8.0±0.3
D	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05
E	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1
F	4.0±0.1	4.0±0.1	2.0±0.05	2.0±0.05
G	2.0±0.05	2.0±0.05	2.0±0.05	2.0±0.05
H	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1
ΦJ	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0
t(max)	1.1±0.05	1.0±0.05	0.8±0.05	0.55±0.05

T* : Product thickness

(2) Dimensions of Reel



A	178±2
B	60±2
C	13.0±0.5
D	21.0±0.8
E	2.0±0.5
W	10.0±1.15
t	1.2±0.2
R	1.0±0.25

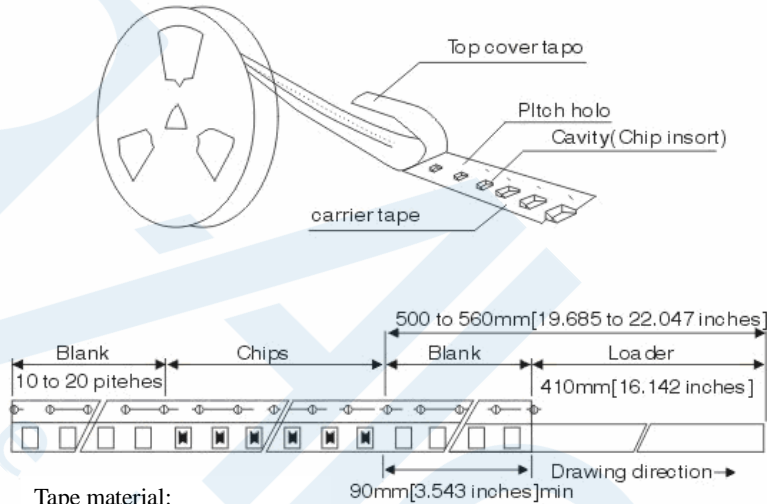
Reel material: PS (Polystyrene)



(3) Pulling strength of tapes

Carrier tape	10N or more (1kgf or more)
Cover tape	5N or more (0.5kgf or more)

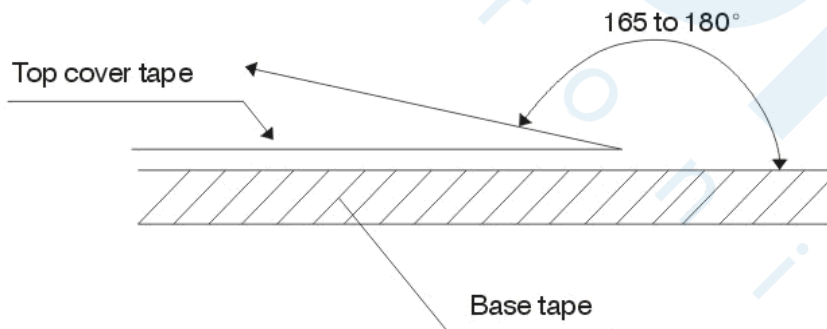
(4) Taping figure and drawing direction



Tape material:
 Base tape: cardboard
 Cover tape: polyethylene

(5) Peeling strength of cover tape

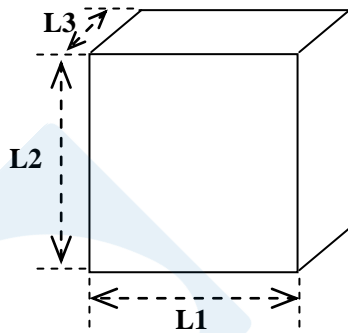
Cover tape	0.3~0.7N (30gf~70gf)
-------------------	----------------------



Test condition:

- 1) peel angle: 165 ~180 °vs. carrier tape.
- 2) peel speed: 300 mm/min±10%.

(6) Box and case dimensions



Unit: mm

Type	L1	L2	L3
Box	180±2	180±2	75±1
Box	180±2	180±2	120±2
Case	400±2	400±2	200±2

- A 6 reels in a box.
- B 10 boxes in a case.

(7) Packaging quantities

Type	Thickness(mm)	Bulk	Tape and reel
2012	0.85±0.20	----	4000pcs
1608	0.8±0.15	----	4000pcs
1005	0.5±0.15	----	10000pcs
0603	0.3±0.05	----	15000pcs

11 Storage

(1) Storage period

Products which inspected in over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solder ability should be checked if this period is exceeded.

(2) Storage conditions

- ① Products should be storage in the warehouse on the following conditions

Temperature: $\cong 40^{\circ}\text{C}$

Humidity : $\cong 70\%$ relative humidity

No rapid change on temperature and humidity

- ② Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solder ability.



- ③ Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- ④ Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- ⑤ Products should be storage under the airtight packaged condition.

12 Usage of Nonflammable Material

For these materials listed below, we don't use in process.

Cd, Hg, As and its compound, PCB, etc.

PBBS, PBBOs, PBDO, PBDE, PBB.

13 Usage of ODS

below, we don't use in process. For ODS listed HCFC ODS: CCL₄, HCFC, etc. ODS.

14 Flammability Class

UL 94V-1

15 Note

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

Please return our copy of this product specification in two month after issued date with your signature of receipt. If the copy is not returned by the date, this product specification will be deemed to have been received.